**TOSHIBA** 2SC5261FT

### TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# 2 S C 5 2 6 1 F T

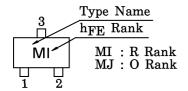
#### VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

Low Noise Figure : NF = 1.7dB (f = 2GHz)High Gain  $: |S_{21e}|^2 = 9.5 dB (f = 2GHz)$ 

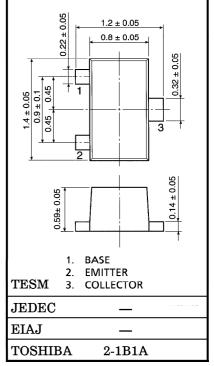
### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$v_{\mathrm{CBO}}$	15	V
Collector-Emitter Voltage	V <sub>CEO</sub>	7	V
Emitter-Base Voltage	$V_{ m EBO}$	1.5	V
Collector Current	$I_{\mathbf{C}}$	15	mA
Base Current	$I_{B}$	7	mA
Collector Power Dissipation	$P_{\mathbf{C}}$	100	mW
Junction Temperature	$T_{j}$	125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	°C

## **MARKING**



# Unit in mm



#### MICROWAVE CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	${ m f_T}$	$V_{CE}=5V, I_{C}=7mA$	9	12	_	GHz
Incortion (Join	$ S_{21e} ^2(1)$	$V_{CE}=5V$ , $I_{C}=7mA$ , $f=1GHz$	_	15.5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE}=5V$ , $I_{C}=7mA$ , $f=2GHz$	6.5	9.5	_	
Noise Figure	NF (1)	$V_{CE}=5V$ , $I_{C}=3mA$ , $f=1GHz$	_	1.3	_	dB
	NF (2)	$V_{CE}=5V$ , $I_{C}=3mA$ , $f=2GHz$	_	1.7	3	αь

### ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{CBO}$	$V_{CB}=10V, I_{E}=0$	_	_	1	$\mu$ A
Emitter Cut-off Current	$I_{EBO}$	$V_{EB} = 1V, I_{C} = 0$	_	_	1	$\mu$ A
DC Current Gain	hFE (Note 1)	$V_{\rm CE}$ =5V, $I_{\rm C}$ =7mA	50	_	160	_
Output Capacitance	$C_{\mathbf{ob}}$	Van - 10V In - 0 f - 1MHz	_	0.45	-	pF
Reverse Transfer Capacitance	$\mathrm{C_{re}}$	$V_{\mathrm{CB}} = 10 \mathrm{V}, \ \mathrm{I_E} = 0, \ \mathrm{f} = 1 \mathrm{MHz}$ (Note 2)	_	0.35	0.75	рF

R:50~100, O:80~160 (Note 1): hFE Classification

(Note 2): Cre is measured by 3 terminal method with capacitance bridge.

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